

**S1A~S1M****1.0Amp Standard Surface Mounted Rectifiers****Features**

- ◆ The plastic package carries Underwriters Laboratory Flammability Classification 94V-0
- ◆ Idea for printed circuit board
- ◆ Glass passivated Junction chip
- ◆ Low reverse leakage
- ◆ High forward surge current capability
- ◆ High temperature soldering guaranteed 250°C/10 seconds at terminals

Mechanical Data

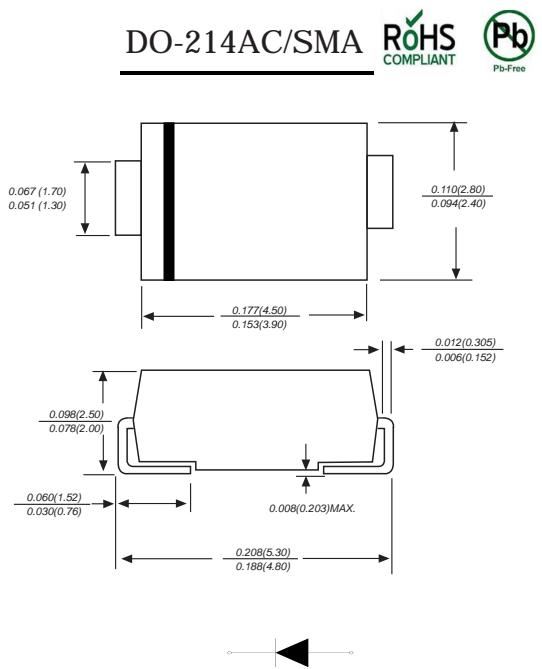
Case : Molded plastic body

Terminals : Solder plated, solderable per MIL-STD-750,Method 2026

Polarity : Polarity symbol marking on body

Mounting Position : Any

Weight : 0.0023 ounce, 0.07 grams



Dimensions in inches and (millimeters)

Maximum Ratings And Electrical Characteristics

Ratings at 25°C ambient temperature unless otherwise specified. Single phase half-wave 60Hz,resistive or inductive load, for capacitive load current derate by 20%.

| Parameter | SYMBOLS | S1A | S1B | S1D | S1G | S1J | S1K | S1M | UNITS |
|--|---------------------|-----|-----|-----|-----|-------------|-----|------|-------|
| Maximum repetitive peak reverse voltage | V _{RRM} | 50 | 100 | 200 | 400 | 600 | 800 | 1000 | V |
| Maximum RMS voltage | V _{RMS} | 35 | 70 | 140 | 280 | 420 | 560 | 700 | V |
| Maximum DC blocking voltage | V _{DC} | 50 | 100 | 200 | 400 | 600 | 800 | 1000 | V |
| Maximum average forward rectified current at T _L =100°C | I _(AV) | | | | | 1.0 | | | A |
| Peak forward surge current, 8.3ms single half sine-wave superimposed on rated load | I _{FSM} | | | | | 30.0 | | | A |
| Maximum instantaneous forward voltage at 1.0A | V _F | | | | | 1.10 | | | V |
| Maximum DC reverse current T _A =25°C at rated DC blocking voltage T _A =125°C | I _R | | | | | 5.0 500 | | | uA |
| Typical junction capacitance (Note1) | C _J | | | | | 18.0 | | | pF |
| Typical thermal resistance | R _{QJA} | | | | | 80.0 | | | °C/W |
| Operating junction and storage temperature range | T _{J,TSTG} | | | | | -55 to +150 | | | °C |

Note: 1.Measured at 1MHz and applied reverse voltage of 4.0V D.C.

Ratings And Characteristic Curves

FIG. 1- DERATING CURVE OUTPUT RECTIFIED CURRENT

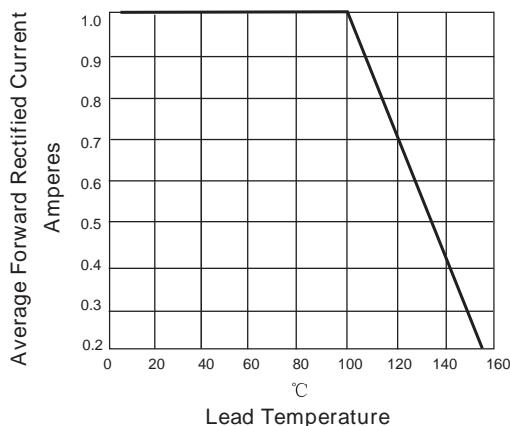


FIG. 2-MAXIMUM NON-REPETITIVE PEAK FORWARD SURGE CURRENT PERLEG

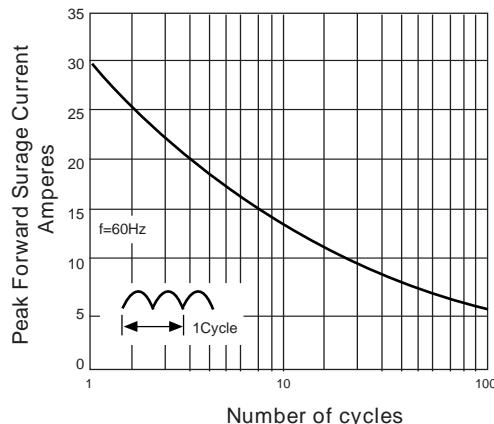


FIG. 3-TYPICAL FORWARD VOLTAGE CHARACTERISTICS

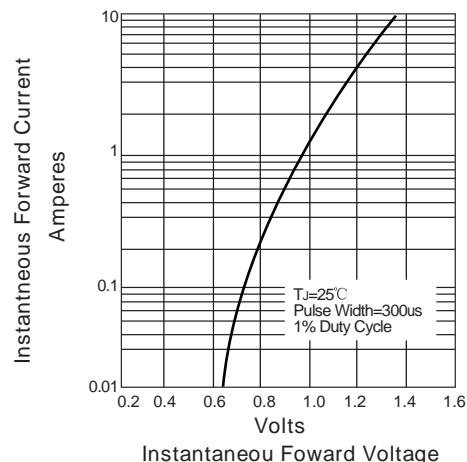
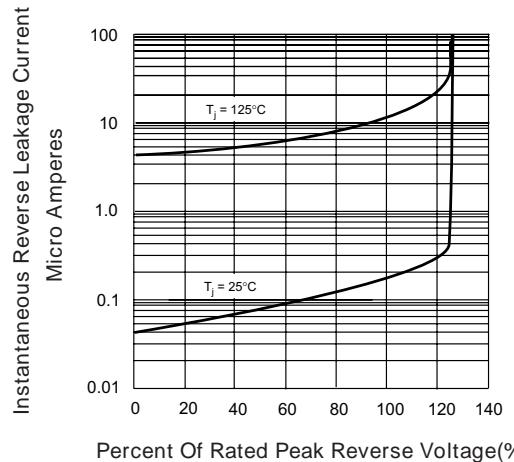
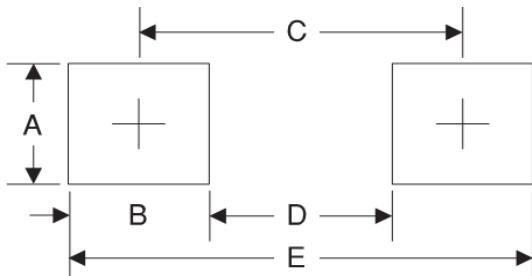


FIG. 4-TYPICAL REVERSE LEAKAGE CHARACTERISTICS

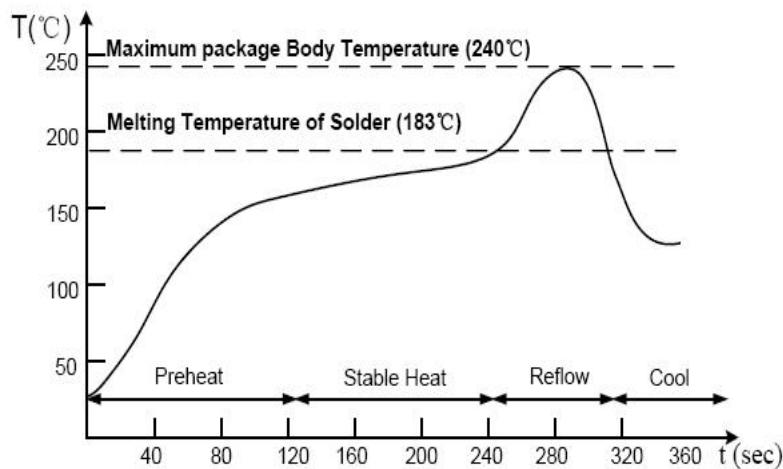


Suggested Pad Layout



| Symbol | Unit (mm) | Unit (inch) |
|--------|-----------|-------------|
| A | 1.68 | 0.066 |
| B | 1.52 | 0.060 |
| C | 3.90 | 0.154 |
| D | 2.41 | 0.095 |
| E | 5.45 | 0.215 |

Suggested Soldering Temperature Profile

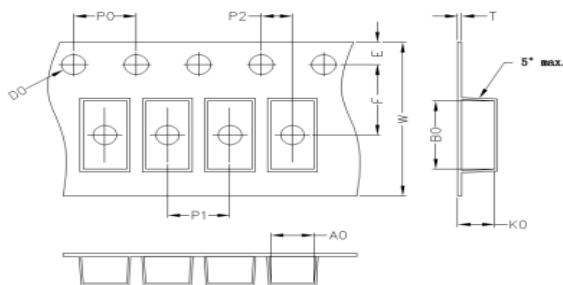


Note

- ◆ Recommended reflow methods: IR, vapor phase oven, hot air oven, wave solder.
- ◆ The device can be exposed to a maximum temperature of 265°C for 10 seconds.
- ◆ Devices can be cleaned using standard industry methods and solvents.
- ◆ If reflow temperatures exceed the recommended profile, devices may not meet the performance requirements.

Package Information

Carrier Dimension(mm)



| A0 | B0 | K0 | D0 | E | F |
|------|------|------|------|------|-----------|
| 2.80 | 5.30 | 2.36 | 1.55 | 1.75 | 5.50 |
| P0 | P1 | P2 | T | W | Tolerance |
| 4.0 | 4.0 | 2.0 | 0.25 | 12 | 0.1 |

Package Specifications

| Package | Reel Size | Reel DIA. (mm) | Q'TY/Reel (Kpcs) | Box Size (mm) | QTY/Box (Kpcs) | Carton Size (mm) | Q'TY/Carton (Kpcs) |
|---------|-----------|-------------------|---------------------|------------------|-------------------|---------------------|-----------------------|
| SMA | 11' | 278 | 5 | 285 | 10 | 355*310*310 | 80 |
| | 13' | 330 | 7.5 | 340 | 15 | 360*360*360 | 120 |